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Pin 1

D5V0L1B2LP

LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

Case Material: Molded Plastic, "Green" Molding Compound. UL

Terminals: NiPdAu over Copper leadframe. Solderable per MIL-

Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV, Contact ±30kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Typically Used in Cellular Handsets, Portable Electronics, Communication Systems, Computers and Peripherals
- Lead Free/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

X1-DFN1006-2



0 Pin 2

Flammability Classification Rating 94V-0

Weight: 0.001 grams (approximate)

Moisture Sensitivity: Level 1 per J-STD-020

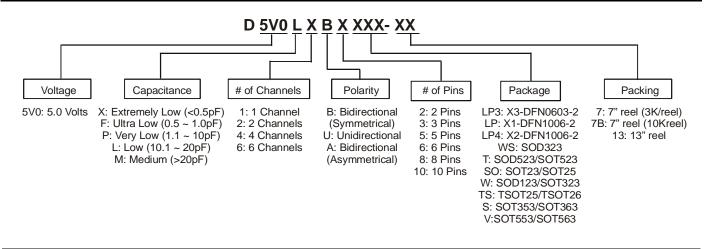
Mechanical Data

Case: X1-DFN1006-2

STD-202, Method 208

Device Schematic

Ordering Information (Note 3)



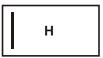
Part Number	Case	Packaging
D5V0L1B2LP-7B	X1-DFN1006-2	10,000/Tape & Reel

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead. Halogen and Antimony free. 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information

Notes:



H = Product Type Marking Code Line Denotes Pin 1



Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P _{PP}	84	W	8/20µs, per Fig. 1
Peak Pulse Current	IPP	6	А	8/20µs, per Fig. 1
ESD Protection – Contact Discharge	V _{ESD_Contact}	±30	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V_{ESD_Air}	±30	kV	IEC 61000-4-2 Standard

Thermal Characteristics

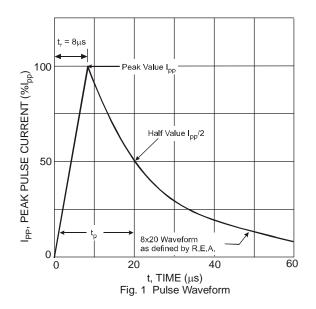
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 4)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 4)	$R_{ heta JA}$	500	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-65 to +150	°C

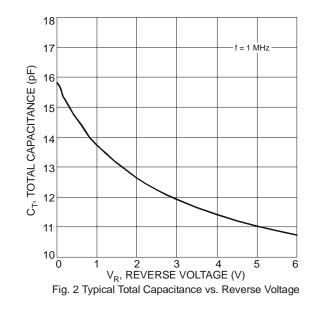
Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	VRWM	-	-	5	V	-
Channel Leakage Current (Note 5)	I _{RM}	-	10	100	nA	$V_{RWM} = 5V$
Clamping Voltage, Positive Transients		-	7.0	9.0	V	$I_{PP} = 1A, t_p = 8/20\mu S$
	V	-	8.7	10.7		$I_{PP} = 3A, t_p = 8/20\mu S$
	V _{CL}	-	10.5	12.0		$I_{PP} = 5A, t_p = 8/20\mu S$
		-	11.5	14.0		$I_{PP} = 6A, t_p = 8/20\mu S$
Breakdown Voltage	V _{BR}	6	7	8	V	I _R = 1mA
Differential Resistance	R _{DIF}	-	0.2	-	Ω	$I_R = 1A, t_p = 8/20\mu S$
Channel Input Capacitance	CIN	-	15	20	pF	$V_R = 0V, f = 1MHz$

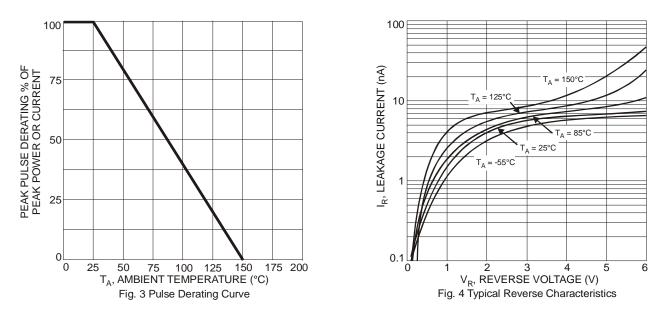
Notes: 4. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.

5. Short duration pulse test used to minimize self-heating effect.

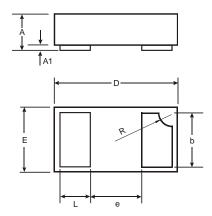






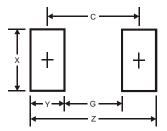


Package Outline Dimensions



X1-DFN1006-2					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0	0.05	0.03		
b	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
е	-	-	0.40		
L	0.20	0.30	0.25		
R	0.05	0.15	0.10		
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.1
G	0.3
Х	0.7
Y	0.4
С	0.7



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 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
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